

DESCRIPTION

The MBT6517 is available in SOT-23 package

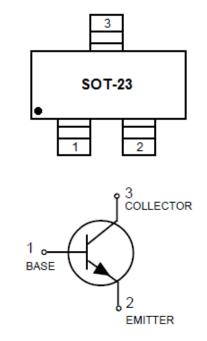
FEATURES

• Available in SOT-23 package

ORDERING INFORMATION

Package Type	Part Number		
SOT-23	MBT6517		
Note	SPQ: 3,000pcs/Reel		
AiT provides all RoHS Compliant Products			

PIN DESCRIPTION



1. BASE

2. EMITTER

3. COLLECTOR



ABSOLUTE MAXIMUM RATINGS

V _{CEO} , Collector–Emitter Voltage	350Vdc
V _{CBO} , Collector–Base Voltage	350Vdc
V _{EBO} , Emitter–Base Voltage	5.0Vdc
I _B , Base Current	250mAdc
Ic, Collector Current — Continuous	500mAdc

Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL CHARACTERISTICS

Parameter	Symbol	Min.	Max.	Unit
Total Device Dissipation FR– 5 Board, NOTE1			225	mW
$T_A = 25^{\circ}C$	PD			
Derate above 25°C			1.8	mW/°C
Thermal Resistance, Junction to Ambient	R _{0JA}		556	°C/W
Total Device Dissipation Alumina Substrate, NOTE2			300	mW
$T_A = 25^{\circ}C$	PD			
Derate above 25°C			2.4	mW/°C
Thermal Resistance, Junction to Ambient	R _{0JA}		417	°C/W
Junction and Storage Temperature	T_J , T_STG	-55	+150	°C

NOTE1: FR-5 = 1.0 x 0.75 x 0.062 in.

NOTE2: Alumina = 0.4 x 0.3 x 0.024 in. 99.5% alumina.



ELECTRICAL CHARACTERISTICS

 $T_A = 25^{\circ}C$, unless otherwise noted.

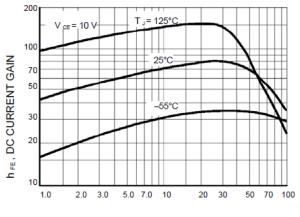
Parameter	Symbol	Conditions	Min.	Max.	Unit
OFF CHARACTERISTICS					
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	I _C = 1.0mAdc	350	-	Vdc
Collector-Base Breakdown Voltage	V _{(BR)CBO}	I _C = 100µAdc	350	-	Vdc
Emitter–Base Breakdown Voltage	V _{(BR)EBO}	I _E = 10μAdc	6.0	-	Vdc
Collector Cutoff Current	Ісво	V _{CB} = 250Vdc	-	50	nAdc
Emitter Cutoff Current	Іево	V _{EB} = 5.0Vdc	-	50	nAdc
ON CHARACTERISTICS	·				
DC Current Gain		I_C = 1.0mAdc, V_{CE} = 10Vdc	20	-	
		I _C = 10mAdc, V _{CE} = 10Vdc	30	-	-
	h _{FE}	I _C = 30mAdc, V _{CE} = 10Vdc	30	200	
		Ic = 50mAdc, V _{CE} = 10Vdc	20	200	
		I_C = 100mAdc, V_{CE} = 10Vdc	15	-	
		I_{C} = 10mAdc, I_{B} = 1.0mAdc	-	0.30	
Collector-Emitter Saturation	V _{CE(sat)}	I_{C} = 20mAdc, I_{B} = 2.0mAdc	-	0.35	Vdc
VoltageNOTE3		I_{C} = 30mAdc, I_{B} = 3.0mAdc	-	0.50	
		I_{C} = 50mAdc, I_{B} = 5.0mAdc	-	1.0	
		I_{C} = 10mAdc, I_{B} = 1.0mAdc	-	0.75	
Base – Emitter Saturation Voltage	V _{BE(sat)}	$I_{\rm C}$ = 20mAdc, $I_{\rm B}$ = 2.0mAdc	-	0.85	Vdc
		I_{C} = 30mAdc, I_{B} = 3.0mAdc	-	0.90	
Base–Emitter On Voltage	V BE(on)	I_{C} = 100mAdc, V_{CE} = 10Vdc	-	2.0	Vdc
SMALL-SIGNAL CHARACTERISTICS	·				
	f⊤	V_{CE} = 20Vdc, I _C = 10mAdc,	40	200	
Current Gain–Bandwidth Product		f = 20 MHz	40 200 N		MHz
Collector –Base Capacitance	C _{cb}	V _{CB} = 20Vdc, f = 1.0 MHz	-	6.0	pF
Emitter –Base Capacitance	Ceb	V _{EB} =0.5Vdc, f = 1.0 MHz	-	80	pF

NOTE3: Pulse Test: Pulse Width = 300µs, Duty Cycle = 2.0%.

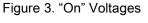


TYPICAL CHARACTERISTICS

Figure 1. DC Current Gain







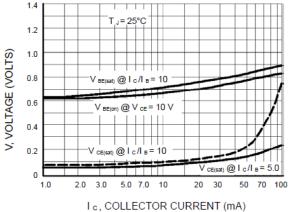


Figure 5. Capacitance

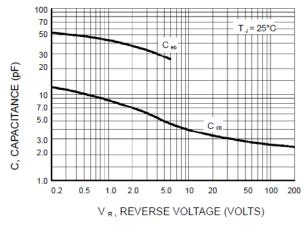
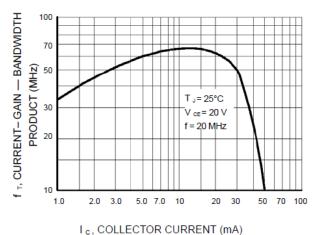
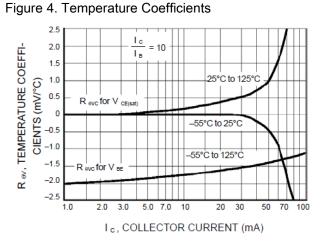


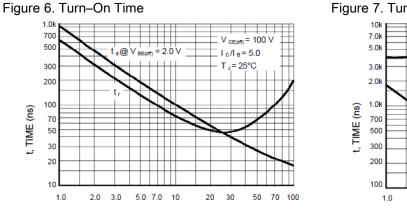
Figure 2. Current–Gain — Bandwidth Product



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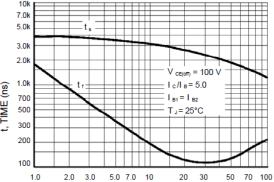




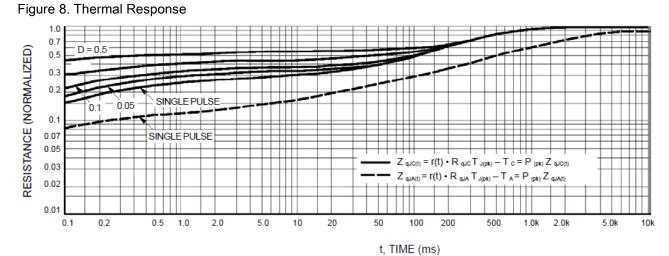


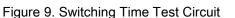
Ic, COLLECTOR CURRENT (mA)

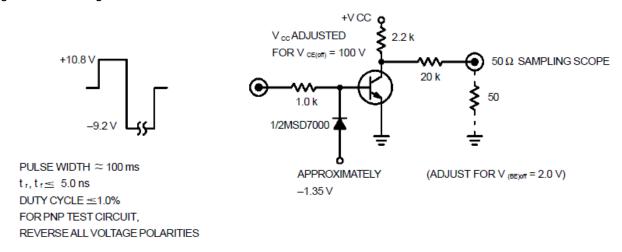
Figure 7. Turn-Off Time



I c, COLLECTOR CURRENT (mA)

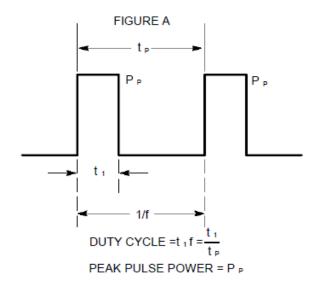








Design Note: Use of Transient Thermal Resistance Data





0.037

0.95

0.079

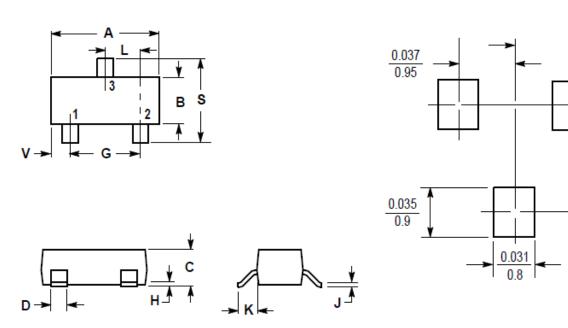
2.0

inches

mm

PACKAGE INFORMATION

Dimension in SOT-23 (Unit: mm)



DIM	MILLIMETERS		INCHES		
	MIN	MAX	MIN	MAX	
А	2.80	3.04	0.1102	0.1197	
В	1.20	1.40	0.0472	0.0551	
С	0.89	1.11	0.0350	0.0440	
D	0.37	0.50	0.0150	0.0200	
G	1.78	2.04	0.0701	0.0807	
Н	0.013	0.100	0.0005	0.0040	
J	0.085	0.177	0.0034	0.0070	
К	0.35	0.69	0.0140	0.0285	
L	0.89	1.02	0.0350	0.0401	
S	2.10	2.64	0.0830	0.1039	
V	0.45	0.60	0.0177	0.0236	



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